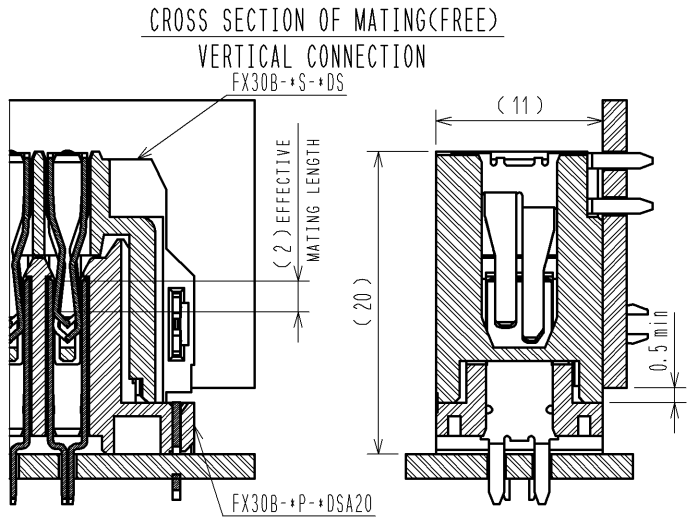
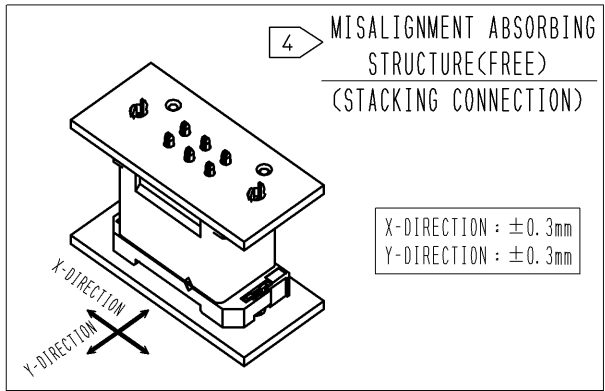
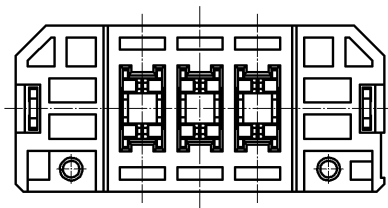
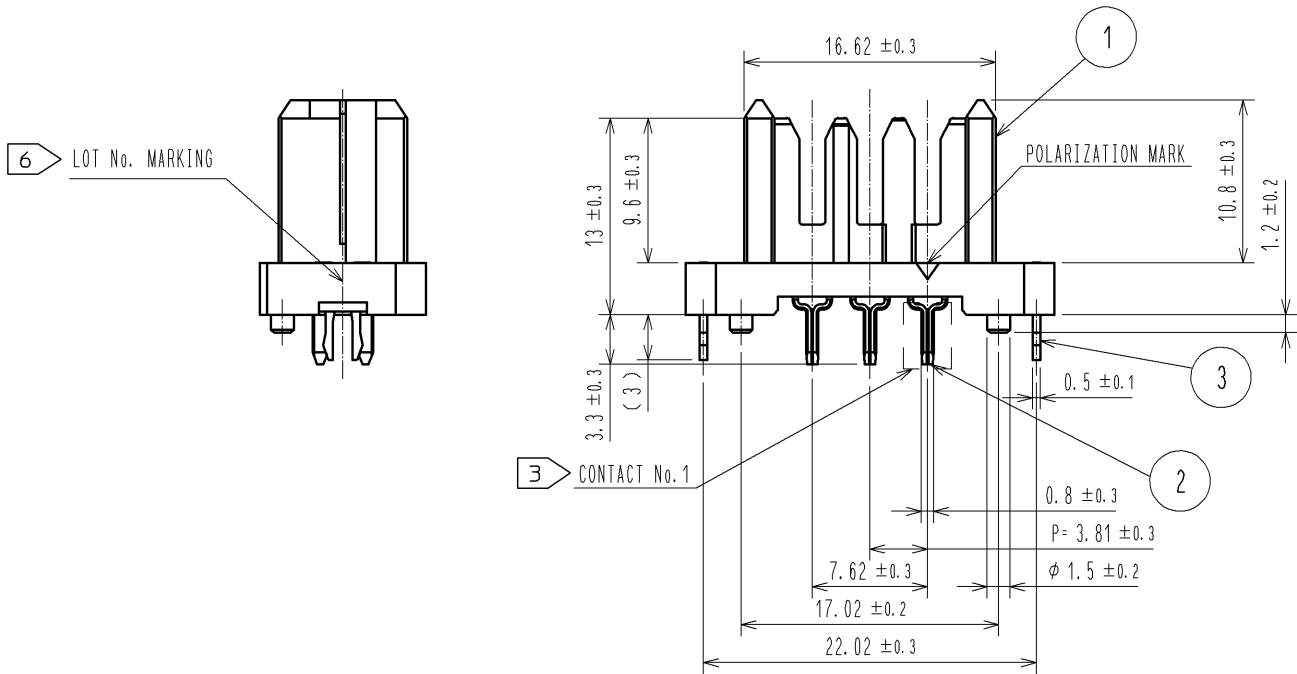
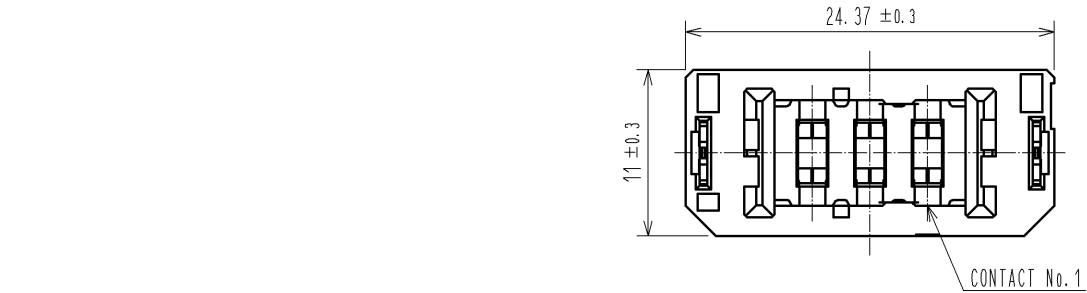
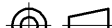




- NOTE
- 1 THIS PRODUCT IS PACKAGED IN TRAY. (42pcs/TRAY)
 - 2 BLEMISH AND HIT MARK CAN BE OCCURED THROUGH OUT THE MANUFACTURING PROCESS WHICH DOSEN'T AFFECT QUALITY LEVEL. ALSO, BLACK SPOT COULD BE OBSERVED ON THE SURFACE OF HOUSING.
 - 3 FOR THE CONTACT NO., ADJACENT TWO PAIRS OF LEADS PLACED BACK-TO-BACK (4 LEADS IN TOTAL) COMPOSE ONE LINE.
 - 4 MISALIGNMENT ABSORBING RANGE: ±0.3mm max.
 - 5 THE DIMENSION IN PARENTHESES ARE FOR REFERENCES.
 - 6 LOT NO. IS INDICATED AT EITHER ONE OF THE POSITION AS SHOWN.

2	COPPER ALLOY	CONTACT AREA:GOLD-PLATING 0.1 μm			4	POLYSTYRENE					
		LEAD AREA:TIN-PLATING 1.0 μm									
		UNDER PLATING:NICKEL 1.0 μm					TIN-PLATING 3.0 μm				
1	POLYAMIDE	BLACK UL94V-0			3	PHOSPHOR BRONZE	UNDER PLATING:NICKEL 1.0 μm				
NO.	MATERIAL	FINISH , REMARKS			NO.	MATERIAL	FINISH , REMARKS				
UNITS mm				SCALE 2 : 1		COUNT 2	DESCRIPTION OF REVISIONS DIS-F-006956		DESIGNED DK. AIMOTO	CHECKED KI. HIROKAWA	DATE 13. 08. 26
 HIROSE ELECTRIC CO., LTD.		APPROVED : HS. OKAWA			13. 03. 13		DRAWING NO. EDC3-347256-00				
		CHECED : KI. HIROKAWA			13. 03. 12		PART NO. FX30B-3P-3. 81DSA20				
		DESIGNED : DK. AIMOTO			13. 03. 11		CODE NO. CL570-3101-6-00				
		DRAWN : DK. AIMOTO			13. 03. 11						
											

A

B

C

D

E

F

A

B

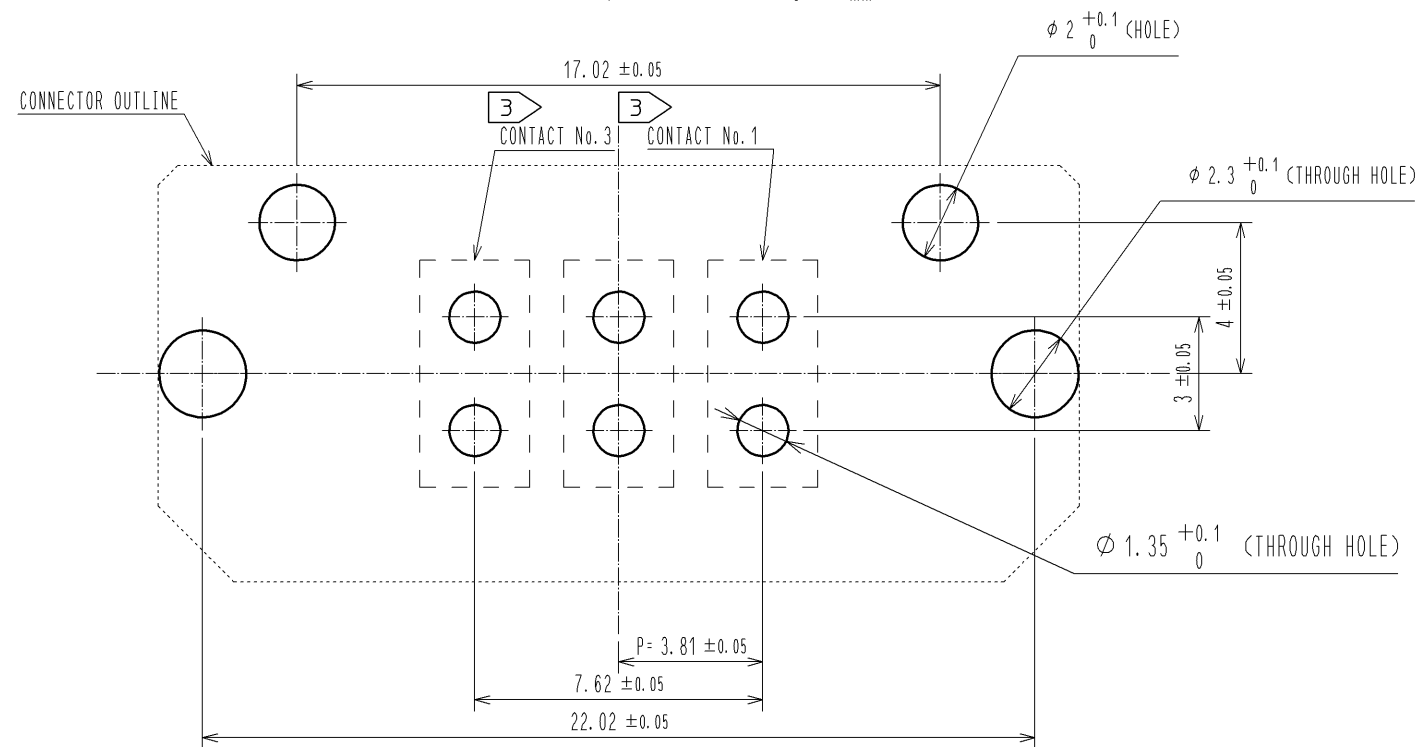
C

D

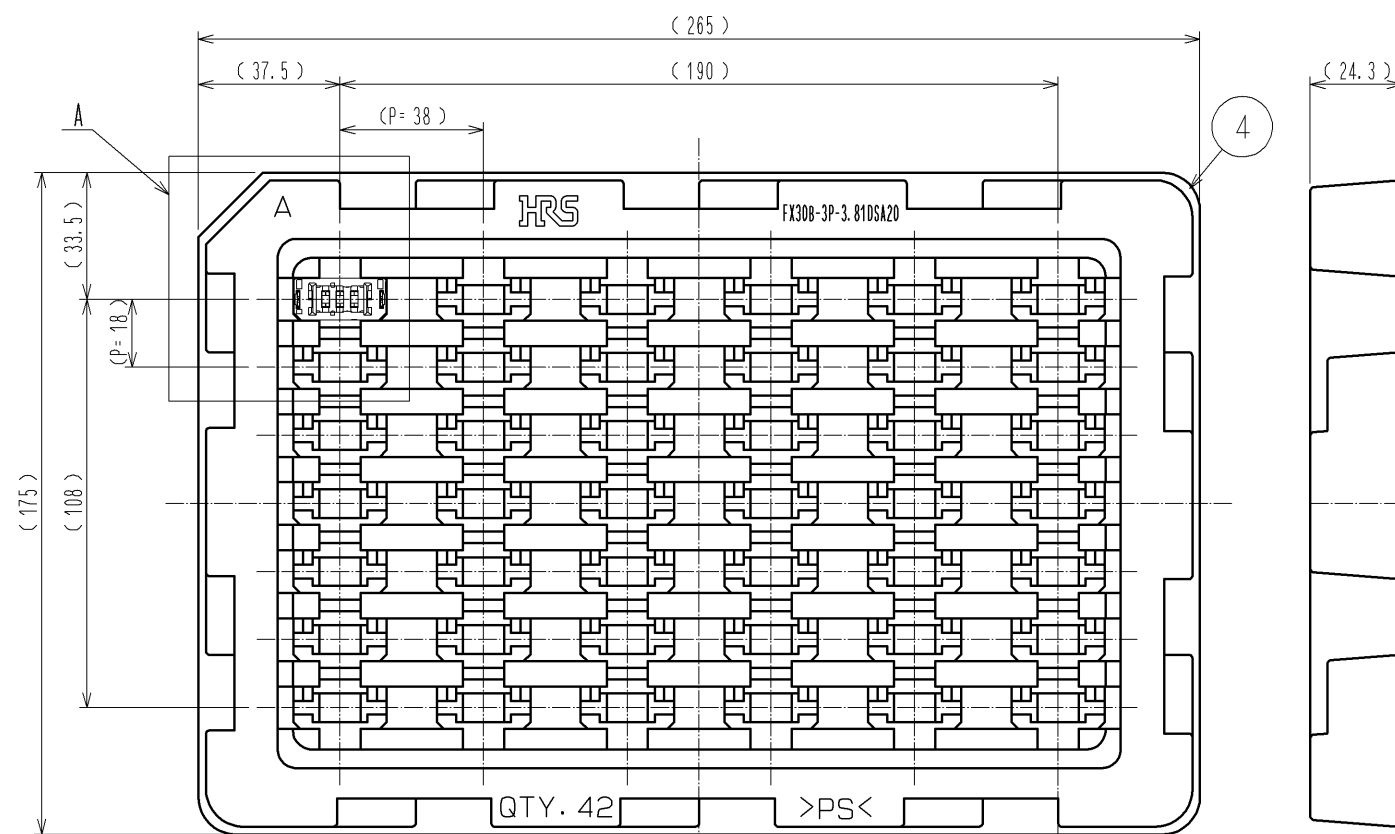
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F

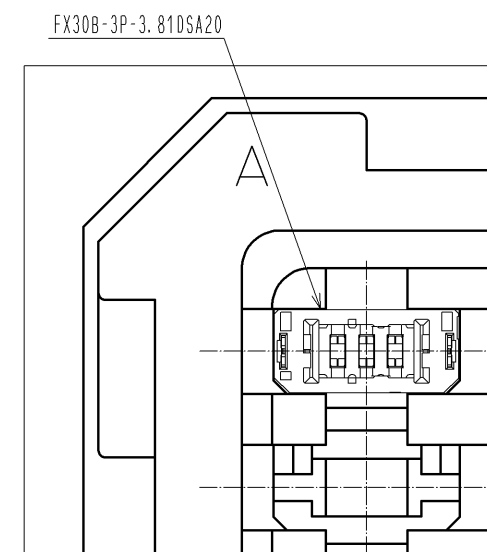
RECOMMENDED HOLE PATTERN DIMENSION OF PCB(5:1)
(CONNECTOR MOUNTING SIDE, PCB THICKNESS: t=1.6mm)



DRAWING FOR PACKAGING(1:2)



A(1:1)



HRS

DRAWING NO.	EDC3-347256-00
PART NO.	FX30B-3P-3.81DSA20
CODE NO.	CL570-3101-6-00

2/2